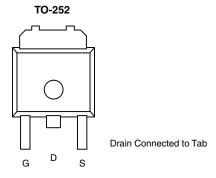


SM6056NSU-VB Datasheet N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A)	Q _g (Typ.)		
60	0.073 at V _{GS} = 10 V	18	19.8		
60	0.085 at V _{GS} = 4.5 V	15	19.0		



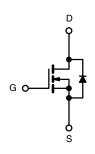
FEATURES

- Trench Power MOSFET
- 100 % R_g and UIS Tested
- Material categorization:
 For definitions of compliance please see

RoHS COMPLIANT HALOGEN

APPLICATIONS

- DC/DC Converters
- DC/AC Inverters
- Motor Drives



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \ ^{\circ}C$, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	60	V			
Gate-Source Voltage		V _{GS}	± 20	v		
Continuous Drain Current	T _C = 25 °C		18			
Continuous Drain Current	T _C = 70 °C	I _D	14	А		
Pulsed Drain Current (t = 300 µs)	I _{DM}	25				
Avalanche Current	I _{AS}	15				
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	11.25	mJ		
Maximum Power Dissipation ^a	T _C = 25 °C	P	41.7 ^b	W		
	T _A = 25 °C ^c	– P _D –	2.1			
Operating Junction and Storage Temp	perature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	60	°C/W		
Junction-to-Case (Drain)	R _{thJC}	3	0/10		

Notes:

a. Duty cycle ≤ 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).

d. Base on T_C = 25 °C.

SPECIFICATIONS ($T_J = 25$ °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.0		3.0	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μΑ	
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	20			А	
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 6.6 A		0.073		0	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6 \text{ A}$		0.085		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 6.6 A		25		S	
Dynamic ^b							
Input Capacitance	C _{iss}			660		pF	
Output Capacitance	C _{oss}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		85			
Reverse Transfer Capacitance	C _{rss}			40			
Total Gate Charge ^c	Qg			19.8	30		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.6 \text{ A}$		3.6		nC	
Gate-Drain Charge ^c	Q _{gd}			4.1			
Gate Resistance	R _g	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	16		
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V}, \text{ R}_{L} = 9.6 \Omega$		11	20		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 5.2$ Å, $V_{GEN} = 10$ V, $R_g = 1 \Omega$		18	27		
Fall Time ^c	t _f			5	10		
Turn-On Delay Time ^c	t _{d(on)}			38	57	ns	
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V}, \text{ R}_{L} = 9.6 \Omega$		58	87	•	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 5.2$ Å, $V_{GEN} = 4.5$ V, $R_g = 1 \ \Omega$		18	27		
Fall Time ^c	t _f			8	16		
Drain-Source Body Diode Ratings a	nd Characteri	stics ^b T _C = 25 °C					
Continuous Current	۱ _S				18	А	
Pulsed Current	I _{SM}				25	A	
Forward Voltage ^a	V _{SD}	I _F = 5.2 A, V _{GS} = 0 V		0.8	1.5	V	
Reverse Recovery Time	t _{rr}			34	51	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 5.2 A, dI/dt = 100 A/μs		3	5	А	
Reverse Recovery Charge	Q _{rr}]		50	75	nC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

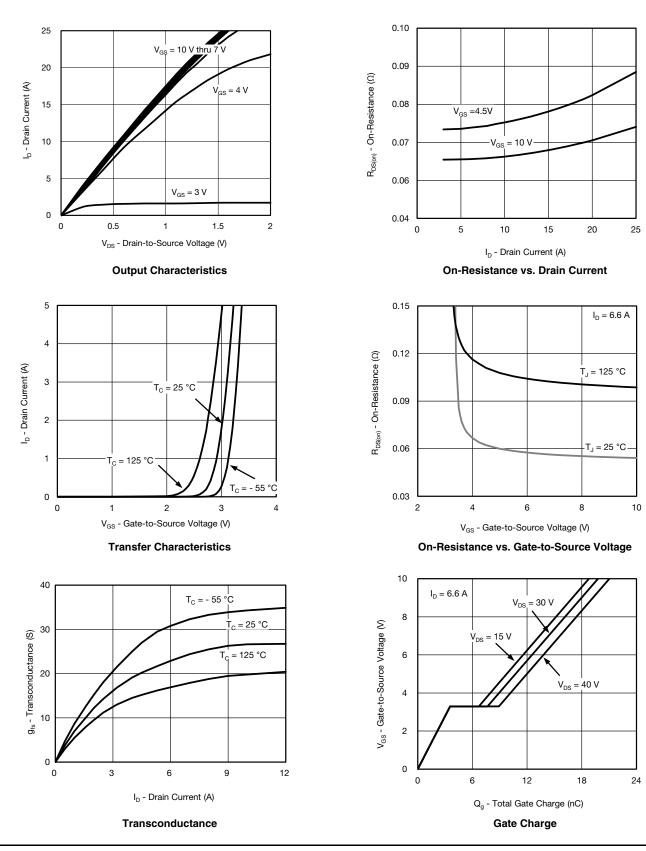
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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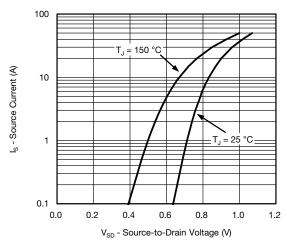




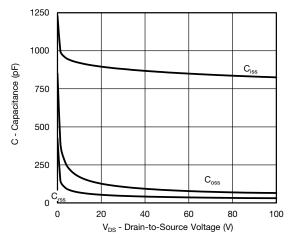
服务热线:400-655-8788



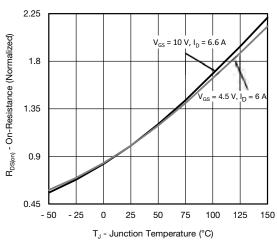
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



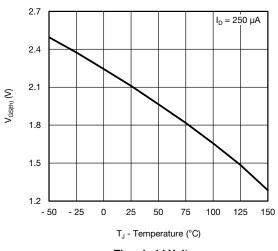
Source-Drain Diode Forward Voltage



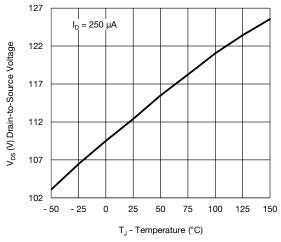




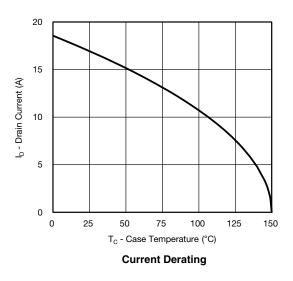
On-Resistance vs. Junction Temperature



Threshold Voltage

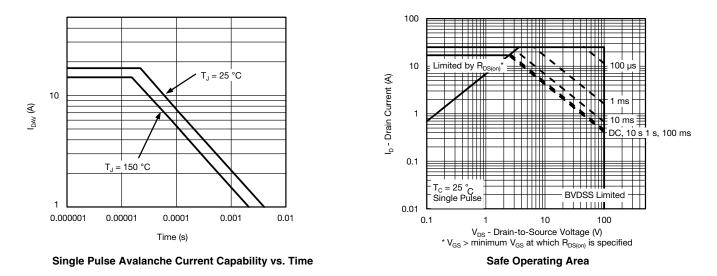


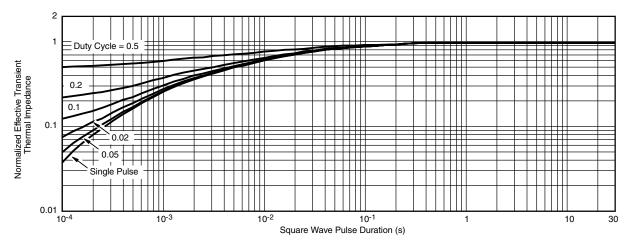
Drain Source Breakdown vs. Junction Temperature





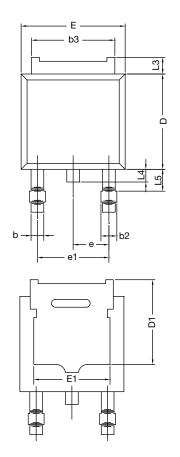
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



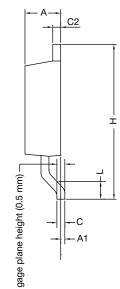


Normalized Thermal Transient Impedance, Junction-to-Case





TO-252AA Case Outline



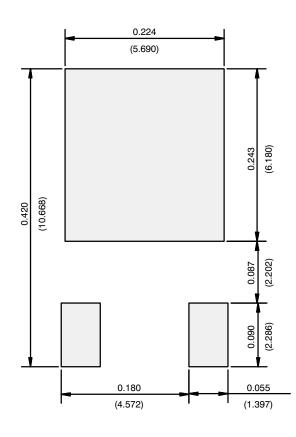
	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	4.10	-	0.161	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
Н	9.40	10.41	0.370	0.410
е	2.28 BSC		0.090 BSC	
e1	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.01	1.52	0.040	0.060
ECN: T16-0236-Rev. P, 16-May-16 DWG: 5347				

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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